IPC ASSOCIATION CONNECTED INDUSTRIANTS	© Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfc Information				
upplier Info	rmation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
onsemi											2025-06-08			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*	Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Reque	Requester Item Number N		Mfr Item Number Mfr Item Name					Version	N	Anufacturing Site	V	eight*	UOM	Unit Type
		FFSD1065B-F085 650V		650V 10A SIC SBD GEN1.5			2025-06-08		C	СРА		29.241	mg	Each
lanufacturin	g Proccess Informa	tion												·
Terminal Plating / Grid Array Material Termin			erminal Base	rminal Base Alloy J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak			Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU			CU Alloy 1				260 C 30			30	seconds 3			
omments														
vel 1 - maximur	n time at peak temperat	ure during sol	dering is 10-3	30 seconds										
or more inform	ation regarding material	composition	please refer t	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.16	mg	Supplier	Silicon Carbide	409-21-2		5.16	mg
Die Attach Solder	5.026		Supplier	Silver (Ag)	7440-22-4		0.1257	mg
			A	Lead (Pb)	7439-92-1	7a	4.6491	mg
			Supplier	Tin (Sn)	7440-31-5		0.2513	mg
Lead Frame	167.854		Supplier	Tin (Sn)	7440-31-5		0.168	mg
			В	Nickel (Ni)	7440-02-0		0.168	mg
			Supplier	Copper (Cu)	7440-50-8		167.518	mg
Mold Compound-Black	149.268	mg		Epoxy resin	proprietary data		8.9561	mg
			Supplier	Phenolic Resin	Proprietary Data		8.9561	mg
			Supplier	Carbon Black (C)	1333-86-4		0.7463	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		126.8778	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3.7317	mg
Plating	1.092	mg	Supplier	Tin (Sn)	7440-31-5		1.092	mg
Wire Bond - Al	0.841	mg	Supplier	Aluminum (Al)	7429-90-5		0.841	mg